TOSHIBA Field Effect Transistor Silicon N-Channel MOS Type ( $\pi$ -MOS VI)

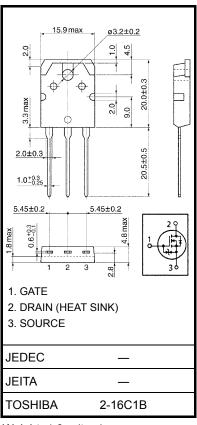
# 2SK4107

### ○ Switching Regulator Applications

- Low drain-source ON resistance :  $R_{DS}$  (ON) = 0. 33  $\Omega$  (typ.)
- High forward transfer admittance  $: |Y_{fs}| = 8.5 \text{ S (typ.)}$
- Low leakage current :  $I_{DSS} = 100 \ \mu A \ (max) \ (V_{DS} = 500 \ V)$
- Enhancement mode :  $V_{th} = 2.0 \sim 4.0 \text{ V} (V_{DS} = 10 \text{ V}, \text{ I}_{D} = 1 \text{ mA})$

#### Absolute Maximum Ratings (Ta = 25°C)

Characteri	stic	Symbol	Rating	Unit
Drain-source voltage		V <sub>DSS</sub>	500	V
Drain-gate voltage (R	<sub>GS</sub> = 20 kΩ)	V <sub>DGR</sub>	500	V
Gate-source voltage		V <sub>GSS</sub>	±30	V
Drain current	DC (Note 1)	I <sub>D</sub>	15	А
	Pulse (Note 1)	I <sub>DP</sub>	60	А
Drain power dissipation	n (Tc = 25°C)	PD	150	W
Single-pulse avalanche	e energy (Note 2)	E <sub>AS</sub>	765	mJ
Avalanche current		I <sub>AR</sub>	15	А
Repetitive avalanche e	nergy (Note 3)	E <sub>AR</sub>	15	mJ
Channel temperature		T <sub>ch</sub>	150	°C
Storage temperature ra	ange	T <sub>stg</sub>	-55~150	°C



Weight: 4.6 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

## **Thermal Characteristics**

Characteristic	Symbol	Max	Unit
Thermal resistance, channel to case	R <sub>th (ch−c)</sub>	0.833	°C/W
Thermal resistance, channel to ambient	R <sub>th (ch−a)</sub>	50	°C/W

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2:  $V_{DD}$  = 90 V,  $T_{ch}$  = 25°C (initial), L = 5.78 mH,  $R_G$  = 25  $\Omega$ ,  $I_{AR}$  = 15 A

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device. Handle with care.

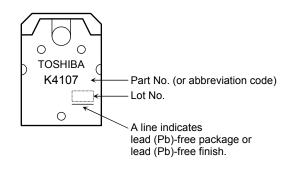
Electrical Characteristics (Ta = 25°C)

Chara	cteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current		I <sub>GSS</sub>	V <sub>GS</sub> = ±25 V, V <sub>DS</sub> = 0 V		_	±10	μA
Gate-source breakdown voltage		V (BR) GSS	I <sub>G</sub> = ±10 μA, V <sub>DS</sub> = 0 V		_	_	V
Drain cutoff curr	rent	IDSS	V <sub>DS</sub> = 500 V, V <sub>GS</sub> = 0 V	_	_	100	μA
Drain-source br	eakdown voltage	V (BR) DSS	I <sub>D</sub> = 10 mA, V <sub>GS</sub> = 0 V	500	_	_	V
Gate threshold	voltage	V <sub>th</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA	2.0	_	4.0	V
Drain-source O	N resistance	R <sub>DS (ON)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 7.0 A	_	0.33	0.4	Ω
Forward transfe	r admittance	Y <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 7.0 A	4.0	8.5	_	S
Input capacitant	ce	C <sub>iss</sub>			2450	_	pF
Reverse transfer capacitance		C <sub>rss</sub>	V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V, f = 1 MHz	_	15	_	
Output capacitance		C <sub>oss</sub>			220	_	
Switching time	Rise time	tr	$V_{GS} \stackrel{10V}{}_{0V} \prod \qquad I_{D} = 7A \qquad \circ V_{out}$ $R_{L} = 30\Omega$ $V_{DD} = 210V$	_	50	_	ns
	Turn-on time	t <sub>on</sub>		_	90	_	
	Fall time	t <sub>f</sub>		_	45	_	
	Turn-off time	t <sub>off</sub>	Duty $\leq 1\%$ , t <sub>w</sub> =10µs		175	_	
Total gate charge (gate-source plus gate-drain)		Qg	V <sub>DD</sub> ≈ 400 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 15 A		48	_	nC
Gate-source charge		Q <sub>gs</sub>			26	_	
Gate-drain ("Miller") charge		Q <sub>gd</sub>		_	22		]

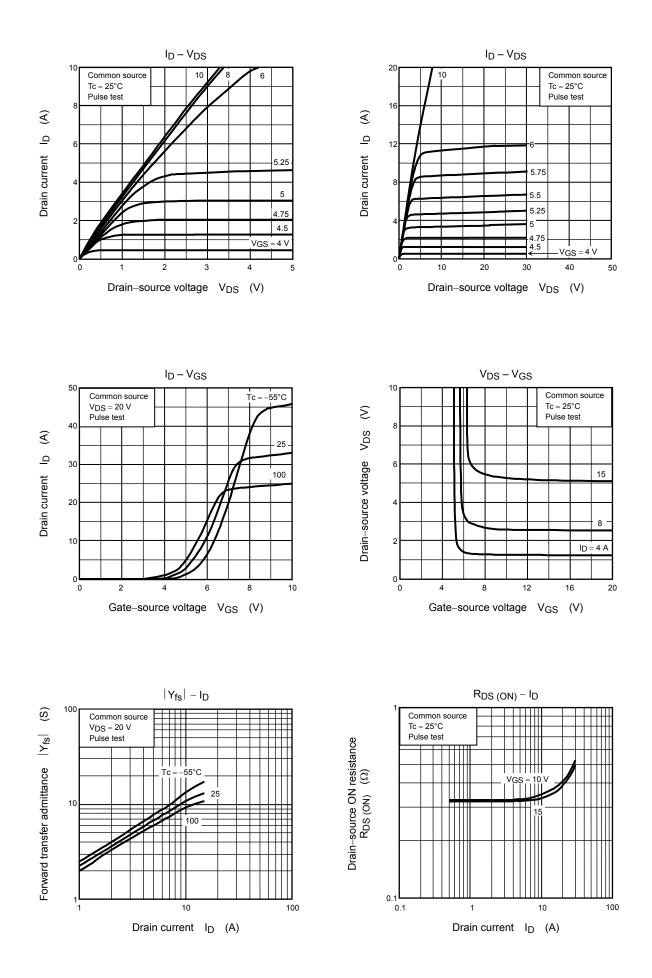
# Source–Drain Ratings and Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition	Min	Тур.	Мах	Unit
Continuous drain reverse current (Note 1)	I <sub>DR</sub>	—	_	_	15	А
Pulse drain reverse current (Note 1)	I <sub>DRP</sub>	—	_	_	60	А
Forward voltage (diode)	V <sub>DSF</sub>	I <sub>DR</sub> = 15 A, V <sub>GS</sub> = 0 V	_	_	-1.7	V
Reverse recovery time	t <sub>rr</sub>	I <sub>DR</sub> = 15 A, V <sub>GS</sub> = 0 V	_	1050	_	ns
Reverse recovery charge	Q <sub>rr</sub>	dI <sub>DR</sub> / dt = 100 A / µs	_	13		μC

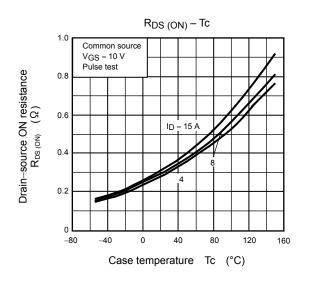
# Marking

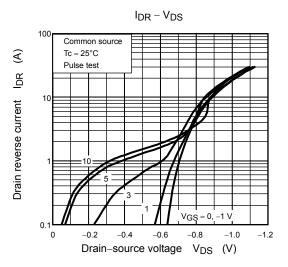


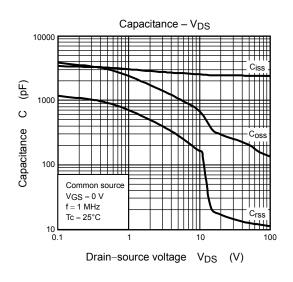
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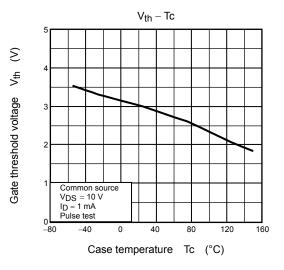


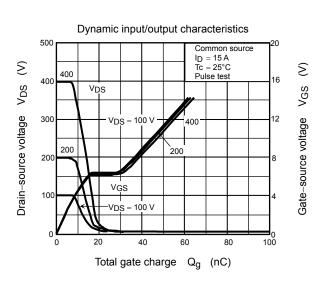
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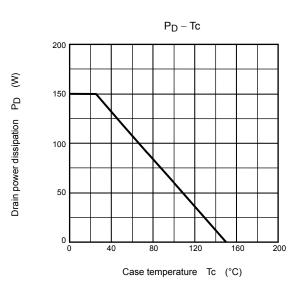


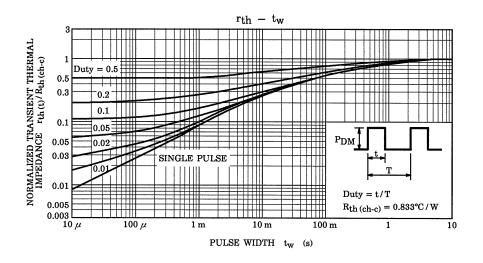


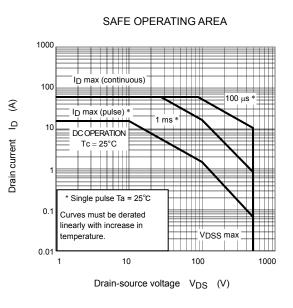




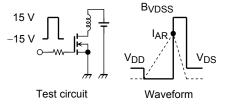








 $E_{AS} - T_{ch}$ (ſш) Avalanche energy EAS Channel temperature (initial) T<sub>ch</sub> (°C)



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